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SPECIFICATION

10

accompanying

Application for Grant of U.S. Letters Patent

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TITLE: COMMON GATE WITH RESISTIVE FEED-THROUGH LOW NOISE
AMPLIFIER

PRIORITY DATA

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This application claims priority to U.S. provisional
application no. 60/435,504, filed December 20, 2002, entitled
"Common Gate with Resistive Feedthrough Low Noise Amplifier,"
which is hereby incorporated by reference for all purposes.

FIELD OF THE INVENTION

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[0001] The present invention pertains to the field of
amplifiers, and in particular to a common gate low noise
amplifier with resistive feed-through for improved noise
performance.

BACKGROUND OF THE INVENTION

[0002] The input stage of the low noise amplifier sets the limits on the sensitivity of the receiver. Therefore, low-noise is one of its most important design goals. 5 Unfortunately, the lower intrinsic gain of transistors at higher frequencies makes it more difficult to achieve a low noise figure at very high frequencies. In such applications, additional noise sources such as gate-induced noise become more prominent with increasing frequency. The low noise 10 amplifier also needs to achieve a sufficient gain to suppress the noise of the following stages and good linearity to handle out-of-band interference while providing a well-defined real impedance, which is normally 50-Ω.

[0003] In order to reduce the effect of noise at high 15 frequency, a common-source stage with inductive degeneration has been used in CMOS low noise amplifier ("LNA") implementations. It can be shown that for an input-matched common-source LNA, the minimum achievable noise factor, F_{min} , and the effective transconductance, G_m , are linearly related to 20 the working frequency, ω_0 , and its inverse, $1/\omega_0$, respectively. Although this common-source topology is well suited for applications at operating frequencies in the low GHz range, its performance degrades substantially at higher frequencies when ω_0 becomes comparable to ω_T .

25 [0004] In contrast, in a common-gate (CG) LNA, the gate-source and gate-drain parasitic capacitances of the transistor are absorbed into the LC tank and resonated out at the operating frequency. Therefore, to the first order, the noise and gain performance of the common-gate stage is independent 30 of the operating frequency, which is a desirable feature for high frequency design. However, due to the constraints of input matching, it can be shown that the noise factor of a

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common-gate LNA has a lower bound of $1+\gamma$ for perfect input match, where γ is the channel thermal noise coefficient. This represents a practical limit for noise reduction that restricts high-frequency applications.

SUMMARY OF THE INVENTION

[0005] In accordance with the present invention, a common-gate low noise amplifier with resistive feed-through is provided that overcomes known problems with high frequency
5 amplifiers.

[0006] In particular, a common-gate low noise amplifier with resistive feed-through is provided that reduces noise effects while maintaining a well-matched input, and that is suitable for applications at either low frequencies or high
10 frequencies.

[0007] In accordance with an exemplary embodiment of the present invention, a radio-frequency amplifier is provided. The radio-frequency amplifier includes a transistor having an input terminal, an output terminal, a control terminal, and a
15 transconductance g_m . A series-connected feed-through resistance R_f and feed-through capacitance C_f is connected in parallel with the input terminal and the output terminal of the transistor. A load resistance R_L is connected to the output terminal. The control terminal of the transistor is
20 biased at a fixed voltage, such as ac ground. Part of the transistor noise follows the looped path through the feed-through resistor instead of passing on to the load, which reduces the noise figure of the amplifier. In addition, the values of g_m , R_f and R_L keep the input impedance of a amplifier
25 matched to a well-defined signal source impedance.

[0008] The present invention provides many important technical advantages. One important technical advantage of the present invention is a high-frequency amplifier with improved noise performance that allows radio-frequency signals to be
30 amplified above 20 GHz without the introduction of significant amounts of noise.

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[0009] Those skilled in the art will further appreciate the advantages and superior features of the invention together with other important aspects thereof on reading the detailed description that follows in conjunction with the drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

- [0010] FIGURE 1 is a diagram of a common gate LNA with resistive feed-through in accordance with an exemplary embodiment of the present invention;
- 5 [0011] FIGURE 2 is a diagram of a common gate LNA with resistive feed-through and a tank circuit in accordance with an exemplary embodiment of the present invention;
- [0012] FIGURE 3 is a gain analysis circuit in accordance with an exemplary embodiment of the present invention;
- 10 [0013] FIGURE 4 is a small-signal equivalent circuit of a common gate resistive feed-through LNA in accordance with an exemplary embodiment of the present invention;
- [0014] FIGURE 5 is a substrate network model for a MOS transistor in accordance with an exemplary embodiment of the present invention;
- 15 [0015] FIGURE 6 is a 24-GHz CMOS LNA in accordance with an exemplary embodiment of the present invention;
- [0016] FIGURE 7 is a diagram of a mixer in accordance with an exemplary embodiment of the present invention;
- 20 [0017] FIGURE 8 is a table presenting measurements from experimental embodiments of an LNA and a mixer;
- [0018] FIGURE 9 shows measured input and output reflection coefficients, S_{11} and S_{22} , for the experimental embodiments of an LNA and a mixer;
- 25 [0019] FIGURE 10 shows the measured power gain and extracted voltage gain for the experimental embodiments of an LNA and a mixer with a 16.9-GHz local oscillator frequency;
- [0020] FIGURE 11 shows the measured large-signal nonlinearity for the experimental embodiments of an LNA and a mixer;
- 30 [0021] FIGURE 12 shows the measured noise figure for the experimental embodiments of an LNA and a mixer.

DETAILED DESCRIPTION OF PREFERRED EMBODIMENTS

[0022] In the description that follows, like parts are marked throughout the specification and drawings with the same reference numerals, respectively. The drawing figures might
5 not be to scale, and certain components can be shown in generalized or schematic form and identified by commercial designations in the interest of clarity and conciseness.

[0023] **FIGURE 1** is a diagram of a common gate LNA 100 with resistive feed-through in accordance with an exemplary
10 embodiment of the present invention. Common gate LNA 100 can be implemented in CMOS or in other suitable manners.

[0024] Common gate LNA 100 includes transistor 102, which can be a CMOS transistor or other suitable devices. Feed-through resistor 104 is provided in parallel with amplifier
15 102, and a feed-through capacitance 106 is used to isolate dc level. The gate of transistor 102 is biased at a fixed voltage, and an inductor 108 provides a dc current path from the input terminal to ground.

[0025] Feed-through resistor 104 forms a closed loop with
20 the transistor 102 channel thermal noise (or shot noise) source. As such, part of the noise signal follows a looped path through feed-through resistor 104 instead of passing on to the load, which reduces the noise figure of the LNA.

[0026] In operation, common gate LNA 100 with feed-through
25 path formed by resistor 104 and capacitance 106 provides for improved performance degradation at higher frequencies. The output noise power due to the transistor channel noise can be lowered towards 0 by reducing resistor 104. The dc current needs to be increased to maintain the gain and input matching.
30 By this means, the topology shown provides a direct way to trade between power dissipation and the noise figure, such that common gate LNA 100 with a feed-through path provides

improved performance at very high frequencies where the noise figure takes precedence over power dissipation.

[0027] **FIGURE 2** is a diagram of a common gate LNA 200 with resistive feed-through and a tank circuit in accordance with an exemplary embodiment of the present invention. As shown, R_s is the signal source impedance, C_p is a large capacitor for isolating dc level, and R_L is the resistive load at the drain of M_1 . Inductors L_L and L_s resonate at the operating frequency with a capacitive load at the drain and source of M_1 , respectively.

[0028] **FIGURE 3** is a gain analysis circuit 300 in accordance with an exemplary embodiment of the present invention. The effective transconductance g_m equals $1/(2 * R_s)$. It should also be noted that g_m is independent of R_f for a matched input.

[0029] **FIGURE 4** is a small-signal equivalent circuit 400 of a common gate resistive feed-through LNA in accordance with an exemplary embodiment of the present invention. In addition to the major noise sources (represented as i_n current sources), g_m is the transistor transconductance, g_{mb} is the backgate transconductance, g_g is the real part of the gate admittance, $\overline{i_{n,d}^2}$ is the transistor channel thermal noise source, and $\overline{i_{n,g}^2}$ is the induced gate noise source. At low frequency, where $\overline{i_{n,g}^2}$ and g_g can be neglected, the feedthrough resistor R_f (which is formed by an external parallel resistance R_p in parallel with the drain-to-source resistance r_{ds}) creates a positive feedback loop around the amplifier to enhance the input impedance. At resonance frequency, the input impedance seen looking into the source of M_1 can be expressed as:

$$Z_{in} = \frac{R_f + R_L}{1 + g_m R_f (1 + \chi)} \quad (1)$$

where g_m is the transistor transconductance and χ is the ratio of the transistor backgate transconductance g_{mb} to g_m . If the input is matched, the effective transconductance of the common gate resistive feed-through stage is given by:

$$G_{m,CGRF} = \frac{1}{2R_s} \quad (2)$$

which indicates that to the first order at the input matching condition, the gain of the common gate resistive feed-through stage is independent of R_f and g_m .

[0030] Assuming a matched input and $R_s \ll R_L$, the output noise power generated by the thermal noise of R_p and R_L is negligible compared to that generated by the transistor channel thermal noise, in which case the noise factor can be approximately expressed as:

$$F_{CGRF} \approx 1 + \frac{\gamma}{\alpha} \left(\frac{1}{1 + \chi} \right)^2 \frac{1}{g_m R_s} \quad (3)$$

where α is the ratio of g_m to the channel conductance at zero drain-to-source voltage, g_{d0} .

[0031] Based on the simplifying assumptions that gate noise and g_g may be ignored, the noise of the common gate resistive feed-through amplifier approaches 0dB by increasing g_m , providing a direct way to trade between power and noise while keeping the input matched. However, at high frequencies, additional effects need to be considered, such as that the coupling between channel and gate is due to a distributed RC network, reflected in the real part of the gate admittance, g_g . In the pinch-off region, g_g is related to operation frequency ω_0 , gate-source capacitance, C_{gs} , and g_{d0} through:

$$g_g = \frac{C_{gs}^2 \omega_0^2}{5g_{d0}} \quad (4)$$

This conductance has a thermal noise, $\overline{i_{n,g}^2}$, associated with it, which is called induced gate noise. The power spectral density of $\overline{i_{n,g}^2}$ is given by:

$$5. \quad \frac{\overline{i_{n,g}^2}}{\Delta f} = 4kT\delta g_g \quad (5)$$

where δ is the gate noise coefficient, and $\overline{i_{n,d}^2}$ and $\overline{i_{n,g}^2}$ are partially correlated with a complex correlation coefficient c given by:

$$c = \frac{\overline{i_{n,g} i_{n,d}^*}}{\sqrt{\overline{i_{n,g}^2} \overline{i_{n,d}^2}}} \quad (6)$$

- 10 Taking g_g into account, the input impedance of the common gate resistive feed-through stage is revised as:

$$Z_{in} = \left(\frac{1 + g_m R_f (1 + \chi)}{R_f + R_L} + \eta(\omega_0) g_m \right)^{-1} \quad (7)$$

where $\eta(\omega_0)$ is defined as the ratio between g_g and g_m :

$$\eta(\omega_0) \equiv \frac{g_g}{g_m} \approx \frac{\alpha}{5} \left(\frac{\omega_0}{\omega_T} \right)^2 \quad (8)$$

- 15 If input is perfectly matched to R_s , the effective transconductance of the common gate resistive feed-through stage is given by:

$$G_{m,CGRF} = \frac{1}{2R_s} [1 - g_m R_s \eta(\omega_0)] \quad (9)$$

- 20 which indicates that a large g_m and high frequency can degrade the gain. This is because the increase of g_m results in a larger g_g causing more signal loss through the gate.

[0032] If a matched input is provided and $R_s \ll R_L$, the

following expression defines the value of F :

$$F_{CGRF} \approx 1 + \frac{\gamma}{\alpha} \left(\frac{1}{1+\chi} \right)^2 \left(\frac{1}{g_m R_s} + \eta^2(\omega_0) g_m R_s + 2\eta(\omega_0) \right) + \delta\eta(\omega_0) g_m R_s \quad (10)$$

where the second term represents the contribution of channel thermal noise and the third term represents the contribution of induced gate noise. At low frequencies, $\eta(\omega_0) \rightarrow 0$, and equation (10) reduces to equation (3).

[0033] An optimum g_m exists for minimum noise figure, i.e.,

$$g_{m,CGRF,opt} = \frac{1}{R_s} \left(\frac{\delta\alpha}{\gamma} (1+\chi)^2 \eta(\omega_0) + \eta^2(\omega_0) \right)^{-\frac{1}{2}} \quad (11)$$

And the corresponding minimum F is approximately given by:

$$F_{CGRF,min} \approx 1 + \gamma \left(\frac{1}{1+\chi} \sqrt{\frac{4\delta}{5\gamma\alpha}} \left(\frac{\omega_0}{\omega_r} \right) + \frac{1}{\alpha(1+\chi)} \frac{2}{5} \left(\frac{\omega_0}{\omega_r} \right)^2 \right) \quad (12)$$

[0034] Since R_f results in positive feedback in the common gate resistive feed-through stage, stability needs to be addressed. Considering the input transistor with feed-through resistor as a two-port network, Z_s and Z_L are the load impedance at the two ports, source and drain, respectively. It is a sufficient condition to prevent oscillation that the real part of both impedances seen looking into the ports, Z_{in} and Z_{out} , are positive. $\text{Re}[Z_{in}]$ and $\text{Re}[Z_{out}]$ can be expressed as

$$\text{Re}[Z_{in}] = \frac{R_f + \text{Re}[Z_L]}{1 + g_m R_f (1 + \chi)} \quad (13)$$

$$\text{Re}[Z_{out}] = R_f + [g_m R_f (1 + \chi) + 1] \text{Re}[Z_s] \quad (14)$$

where $R_f = R_p \parallel r_{ds}$, and equations (13) and (14) indicate that as long as $\text{Re}[Z_L]$ and $\text{Re}[Z_s]$ are positive, stability of the common gate resistive feed-through stage is provided.

[0035] FIGURE 5 is a substrate network model 500 for a MOS transistor in accordance with an exemplary embodiment of the

present invention. Capacitive coupling between the drain and source through this network adversely affects stability and the noise figure. A shunt inductor L_p in series with a large bypass capacitor C_p resonates the equivalent capacitance between drain and source so that the substrate effects are reduced. The series resistance of L_p can be converted to an equivalent parallel resistance, which affects the performance of the LNA as a feed-through resistor. In this case, the feed-through resistance can be expressed as

$$R_f = Q\omega_0 L_p \parallel r_{ds} \quad (15)$$

where R_{Lp} is the series resistance of L_p .

[0036] **FIGURE 6** is a 24-GHz CMOS LNA 600 in accordance with an exemplary embodiment of the present invention. An experimental embodiment of LNA 600 was also constructed, and test results from tests performed on that experimental embodiment are discussed herein in greater detail.

[0037] LNA 600 includes three stages. The first stage employs a common-gate with resistive feed-through topology, where shunt inductor L_2 resonates the capacitive coupling between the drain and the source of M_1 , while its parasitic resistance R_{L2} introduces a feed-through resistance described by equation (15). A large capacitor C_2 isolates the dc level of the source and the drain. The second and third stages are both common-source with inductive degeneration amplifiers, which are used to enhance the overall gain.

[0038] The peak f_T of the 0.18- μm CMOS device used at 1.5 V bias is about 60 GHz. To achieve the minimum noise figure at 24 GHz, the optimum g_{m1} is estimated to be about 80 mS in accordance with equation (11). To reduce the power consumption, g_{m1} is set to 40 mS. $(V_{gs} - V_t)$ is also lowered by a factor of two from its value of peak f_T , which is a power

efficient way for reducing current consumption by more than 50%, while reducing f_T by about 10% only. Finally M_1 is biased at 8mA with 54 GHz f_T . The second and third stages consume 4mA each.

5 [0039] Since the feed-through resistor is replaced by an inductor in the first stage, the stability of the amplifier needs to be reexamined. Computer circuit simulations show that the first stage is stable up to 43 GHz. Above 43 GHz, the stability factor of the stage, K_f , is less than one.
10 However, the input impedance of the second stage is located in the stable region with sufficient margin for stable operation in the frequency range of interest.

[0040] FIGURE 7 is a diagram of a mixer 700 in accordance with an exemplary embodiment of the present invention. A
15 conventional single-balanced Gilbert cell is used, and the RF input is applied at the gate of M_4 which is used as a transconductance amplifier. The linearity of this transconductance amplifier is improved by using source degeneration inductor L_S , which also adjusts the input
20 impedance seen looking into the gate of M_4 in order to improve the power matching at the LNA-mixer interface. M_4 is biased at 4mA dc current.

[0041] The chopping function of mixer 700 is accomplished by the M_2 - M_3 mixing cell and a 1.6 V peak-to-peak differential
25 LO signal is applied. Cascode amplifiers following the differential mixing cell are used to drive the 50- Ω loads. The output-match is accomplished by the LC impedance transforming network.

[0042] FIGURE 8 is a table 800 presenting measurements from
30 experimental embodiments of LNA 600 and mixer 700. The circuits were designed and fabricated using 0.18- μ m CMOS transistors. The process used to fabricate the experimental

embodiments used six metal layers with two top layers of 1- μ m thick copper. The inductors L_4 and L_6 of LNA 600 and L_8 of mixer 700 were implemented as slab inductors, and the remaining inductors were implemented as spirals. Shielded pads were employed at both transmission frequency and intermediate frequency ports. Grounded metal underneath the pads prevented loss of the signal power and noise generation associated with substrate resistance.

[0043] Ground rings were placed around each transistor at a minimum distance to reduce the substrate loss. Separated V_{dd} pads were assigned to LNA 600, mixer 700, and bias circuits. Large on-chip bypass capacitors were placed between each V_{dd} and ground. The size of the chip was 0.8 x 0.9 mm including a large area occupied by the wide ground rings and pads. The size of the core cell was only 0.4 x 0.5 mm.

[0044] The image rejection of the front-end was -31 dB. This performance was achieved via the large intermediate frequency and the multi-stage nature of LNA 600. The overall current consumption of the front-end was 43 mA, out of which the output buffers consumed 23 mA. The experimental embodiments of LNA 600 and mixer 700 drew 16mA and 4mA, respectively, from a 1.5-V supply voltage.

[0045] FIGURE 9 shows the measured input and output reflection coefficients, S_{11} and S_{22} , for the experimental embodiments of LNA 600 and mixer 700. As shown by these measurements, the radio frequency input and the intermediate frequency output are well matched at the respective frequencies.

[0046] FIGURE 10 shows the measured power gain and extracted voltage gain for the experimental embodiments of LNA 600 and mixer 700 with a 16.9-GHz local oscillator frequency. The measurement shows that a 27.5 dB maximum power gain

appears for a transmission frequency of 21.8 GHz and an intermediate frequency of 4.9 GHz. The frequency offset from the 24 GHz is likely due to inaccurate modeling of the MOS transistor and the planar inductor at high frequencies. The experimental embodiment of LNA 600 achieved a 15-dB power gain. The experimental embodiment of mixer 700 further enhanced the signal power by 13 dB. Because of the imperfect conjugate-matching at the LNA-mixer interface, the overall power gain of the front-end was slightly lower than the sum of the individual power gain of the two blocks.

[0047] FIGURE 11 shows the measured large-signal nonlinearity for the experimental embodiments of LNA 600 and mixer 700. The input referred 1dB compression points appears at -23dBm.

[0048] FIGURE 12 shows the measured noise figure for the experimental embodiments of LNA 600 and mixer 700. A minimum noise figure of 7.7 dB was achieved for the combined LNA 600 and mixer 700 at 22.08 GHz. The individual noise figures of LNA 600 and mixer 700 were 6 dB and 17.5 dB, respectively. The noise figure of the first common gate resistive feed-through stage was extracted to be 4.8 dB. Applying equation (3) predicts the $\overline{i_{n,d}^2}$ only noise figure of the first stage to be 3.3dB. Applying equation (10) adjusts the prediction of the noise figure to be 4.1 dB by taking g_g and $\overline{i_{n,g}^2}$ into account, and the remaining amount of 0.7 dB is due to the thermal noise of the parasitic resistance and substrate noise.

[0049] Although exemplary embodiments of a system and method of the present invention have been described in detail herein, those skilled in the art will also recognize that various substitutions and modifications can be made to the systems and methods without departing from the scope and

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spirit of the appended claims.